



# CT415 Series DC Input 4-Pin Mini-Flat DMC-Isolator® Photodarlington Optocoupler

## Features

- High isolation 3750 VRMS
- Patented coplanar structure DMC-Isolator®
- Various CTR selection available
- DC input with Darlington output
- Operating Temperature range - 55 °C to 110 °C
- External Creepage  $\geq 5.0\text{mm}$
- Distance Through Isolation  $\geq 0.4\text{mm}$
- Clearance Distance  $\geq 5.0\text{mm}$
- RoHS and REACH Compliance
- Halogen Free Compliance
- MSL class 1
- Regulatory Approvals
  - ✓ UL - UL1577 (E364000)
  - ✓ VDE - EN60747-5-5(VDE0884-5)
  - ✓ CQC – GB4943.1, GB8898 (14001105803)
  - ✓ IEC62368 (FI/41119)

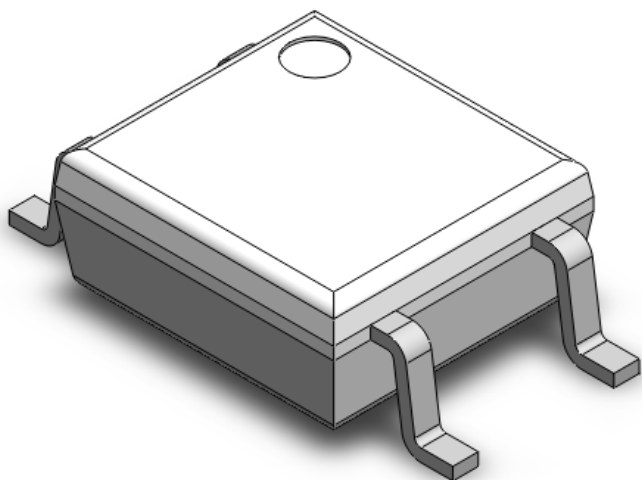
## Description

The CT415 series consists of a photodarlington transistor optically coupled to an Infrared-emitting diode in a 4-lead Mini-Flat DMC-Isolator® package with bending option.

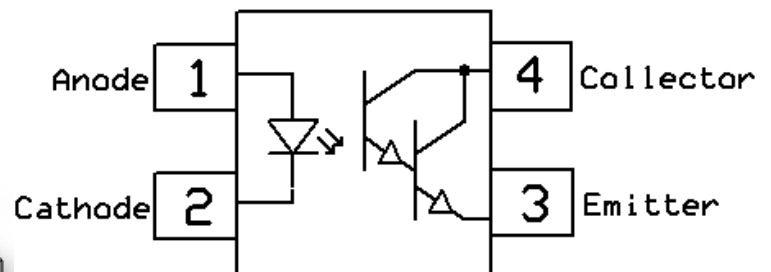
## Applications

- Power supply regulators
- Digital logic outputs
- Microprocessor inputs

## Package Outline



## Schematic





# CT415 Series

## DC Input 4-Pin Mini-Flat DMC-Isolator®

### Photodarlington Optocoupler

#### Absolute Maximum Ratings $T_A = 25^{\circ}\text{C}$ , unless otherwise specified

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters	Ratings	Units	Notes
$V_{\text{ISO}}$	Isolation voltage (AC, 1 minute, 40 ~ 60% R.H.)	3750	$V_{\text{RMS}}$	
$T_{\text{OPR}}$	Operating temperature	-55 ~ +110	$^{\circ}\text{C}$	
$T_{\text{STG}}$	Storage temperature	-55 ~ +150	$^{\circ}\text{C}$	
$T_{\text{SOL}}$	Soldering temperature (For 10 seconds)	260	$^{\circ}\text{C}$	
$P_{\text{TOT}}$	Total power dissipation	170	mW	
<b>Emitter</b>				
$I_{\text{F}}$	Forward current	50	mA	
$I_{\text{F(TRANS)}}$	Peak transient current ( $\leq 1\mu\text{s P.W, 300pps}$ )	1	A	
$V_{\text{R}}$	Reverse voltage	6	V	
$P_{\text{D}}$	Power dissipation	70	mW	
<b>Detector</b>				
$P_{\text{D}}$	Power dissipation	150	mW	
$B_{\text{VCEO}}$	Collector-Emitter Breakdown Voltage	35	V	
$B_{\text{VECO}}$	Emitter-Collector Breakdown Voltage	7	V	
$I_{\text{C}}$	Collector Current	80	mA	



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## Electrical Characteristics $T_A = 25^\circ\text{C}$ (unless otherwise specified)

### Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
$V_F$	Forward voltage	$I_F = 10\text{mA}$		1.4	1.6	V	
$I_R$	Reverse Current	$V_R = 6\text{V}$	-	-	5	$\mu\text{A}$	
$C_{IN}$	Input Capacitance	$f = 1\text{MHz}$	-	30	250	pF	

### Detector Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
$B_{V_{CEO}}$	Collector-Emitter Breakdown	$I_C = 100\mu\text{A}$	35	-	-	V	
$B_{V_{ECO}}$	Emitter-Collector Breakdown	$I_E = 100\mu\text{A}$	7	-	-	V	
$I_{CEO}$	Collector-Emitter Dark Current	$V_{CE} = 10\text{V}, I_F = 0\text{mA}$	-	-	100	nA	

### Transfer Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes	
CTR	Current Transfer Ratio	$I_F = 1\text{mA}, V_{CE} = 2\text{V}$	CT415	600	-	-	%	
			CT415A	3000	-	6500		
			CT415B	5500	-	-		
$V_{CE(SAT)}$	Collector-Emitter Saturation Voltage	$I_F = 20\text{mA}, I_C = 5\text{mA}$	-	0.8	1	V		
$R_{IO}$	Isolation Resistance	$V_{IO} = 500\text{V}_{DC}$	$5 \times 10^{10}$			$\Omega$		
$C_{IO}$	Isolation Capacitance	$f = 1\text{MHz}$		0.5	1	pF		

### Switching Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
$t_r$	Rise Time	$I_C = 10\text{mA}, V_{CE} = 2\text{V}, R_L = 100\Omega$	-	-	300	$\mu\text{s}$	
$t_f$	Fall Time		-	-	250		



# CT415 Series DC Input 4-Pin Mini-Flat DMC-Isolator® Photodarlington Optocoupler

## Typical Characteristic Curves $T_A = 25^\circ\text{C}$ , unless otherwise specified

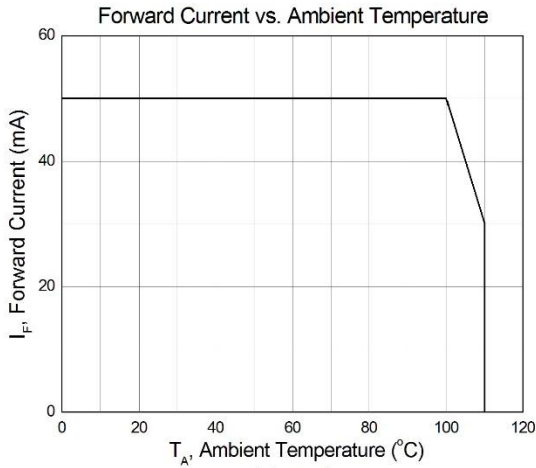


Figure 1

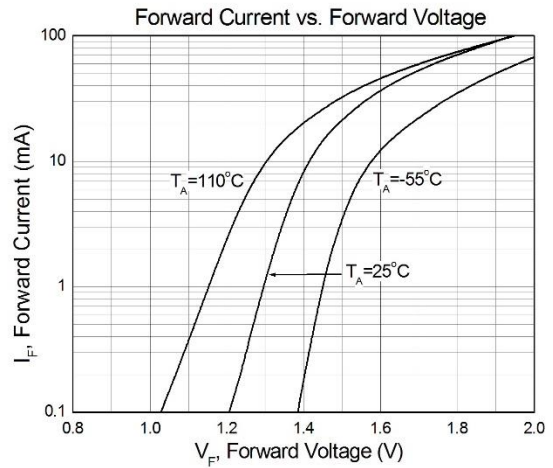


Figure 2

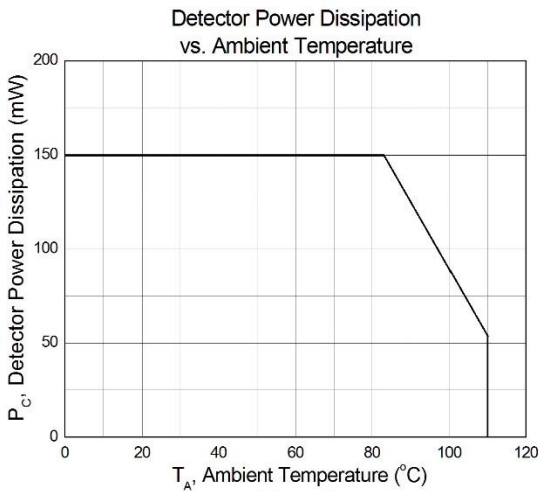


Figure 3

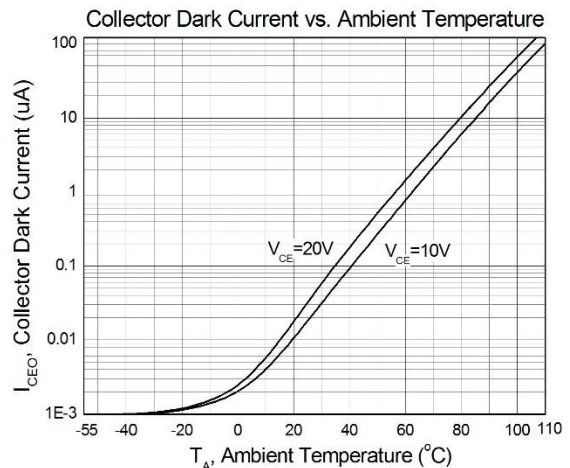


Figure 4

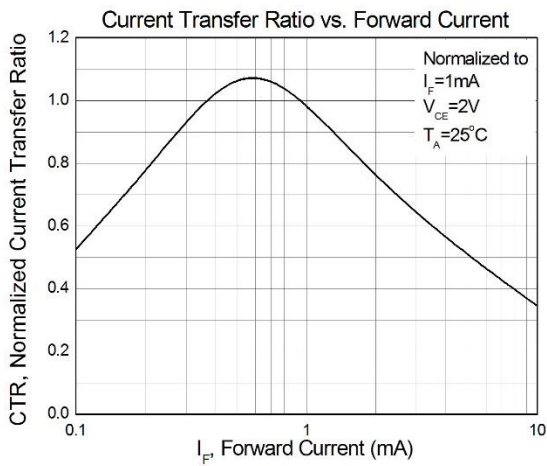


Figure 5

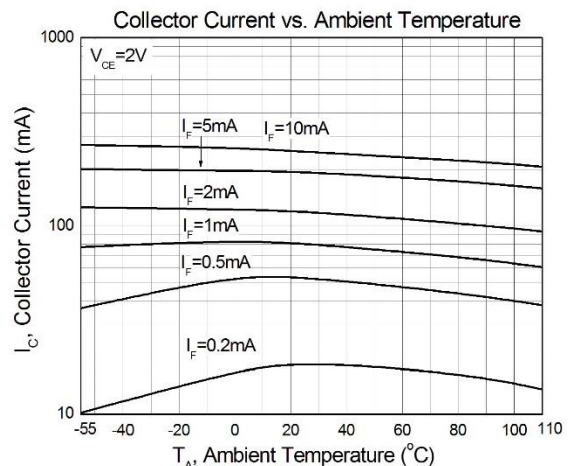


Figure 6



### Typical Characteristic Curves $T_A = 25^\circ\text{C}$ , unless otherwise specified

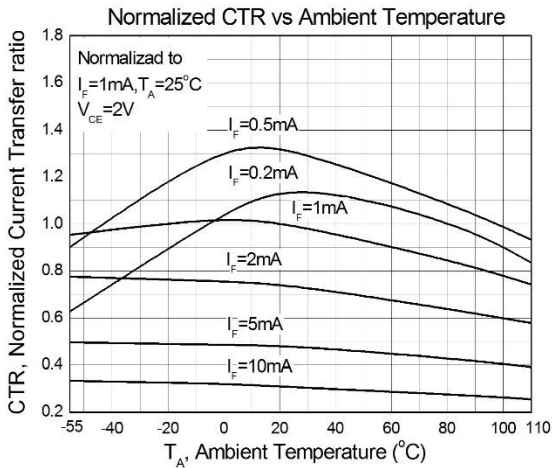


Figure 7

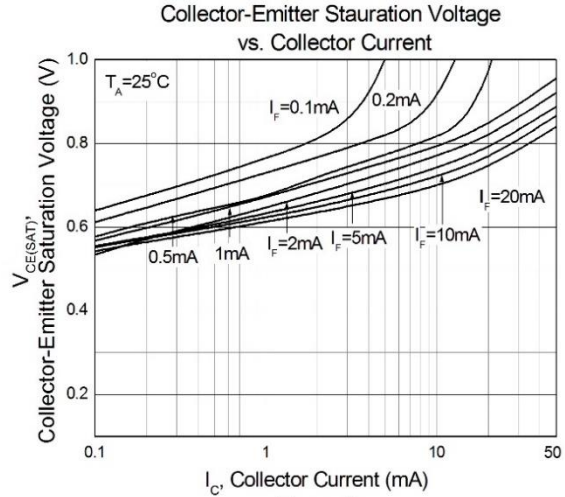


Figure 8

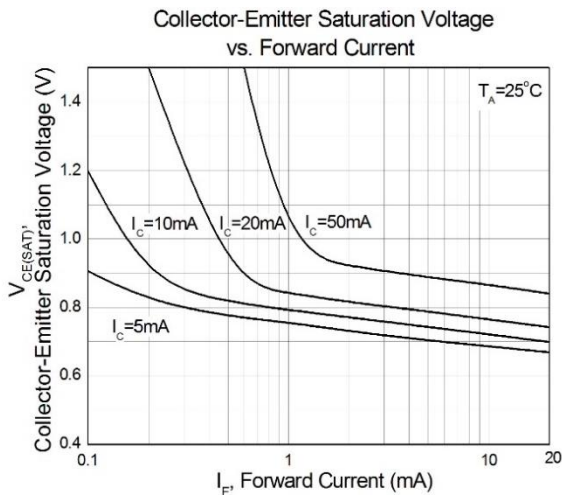


Figure 9

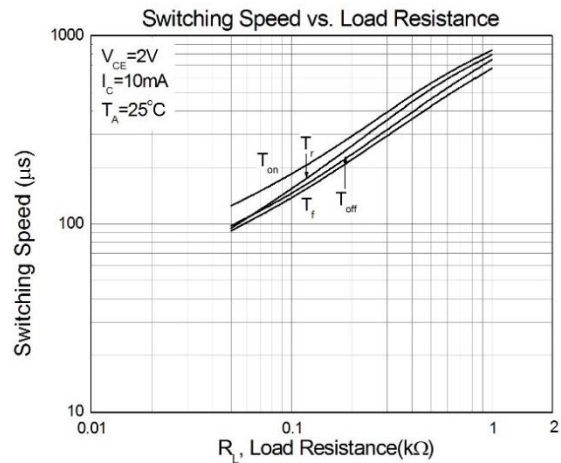


Figure 10

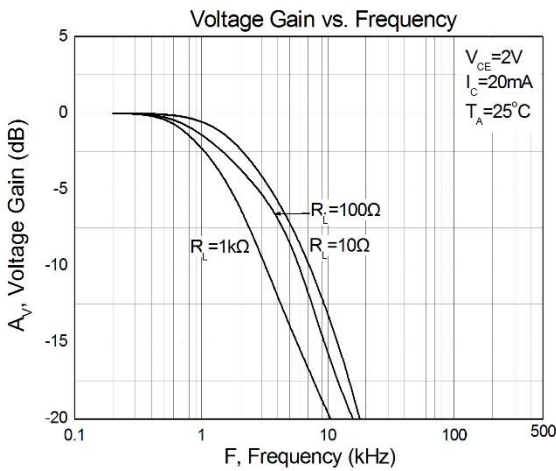


Figure 11

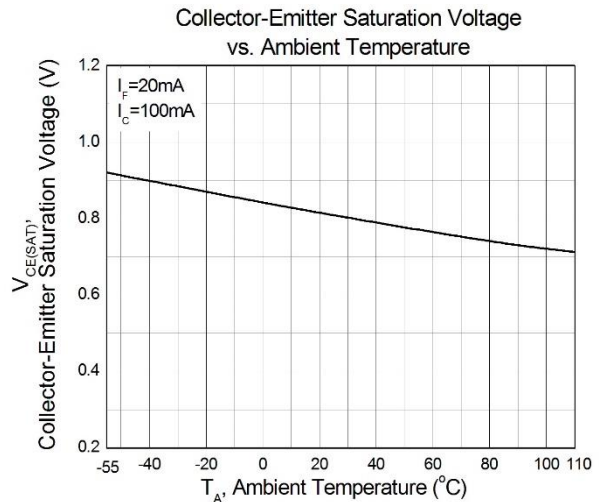


Figure 12



## Test Circuit

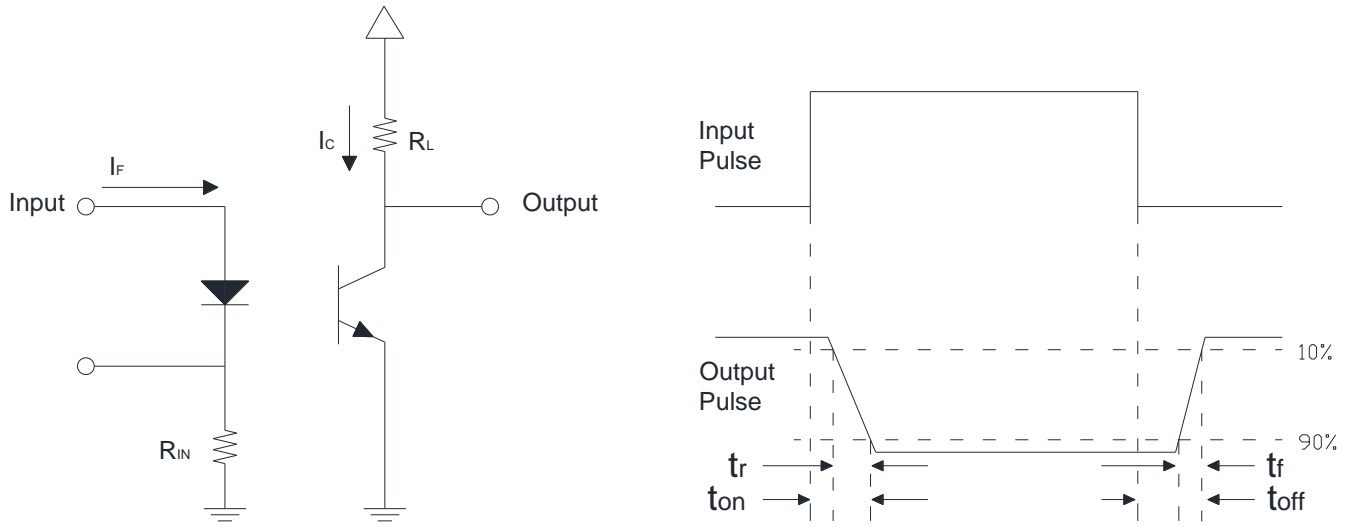


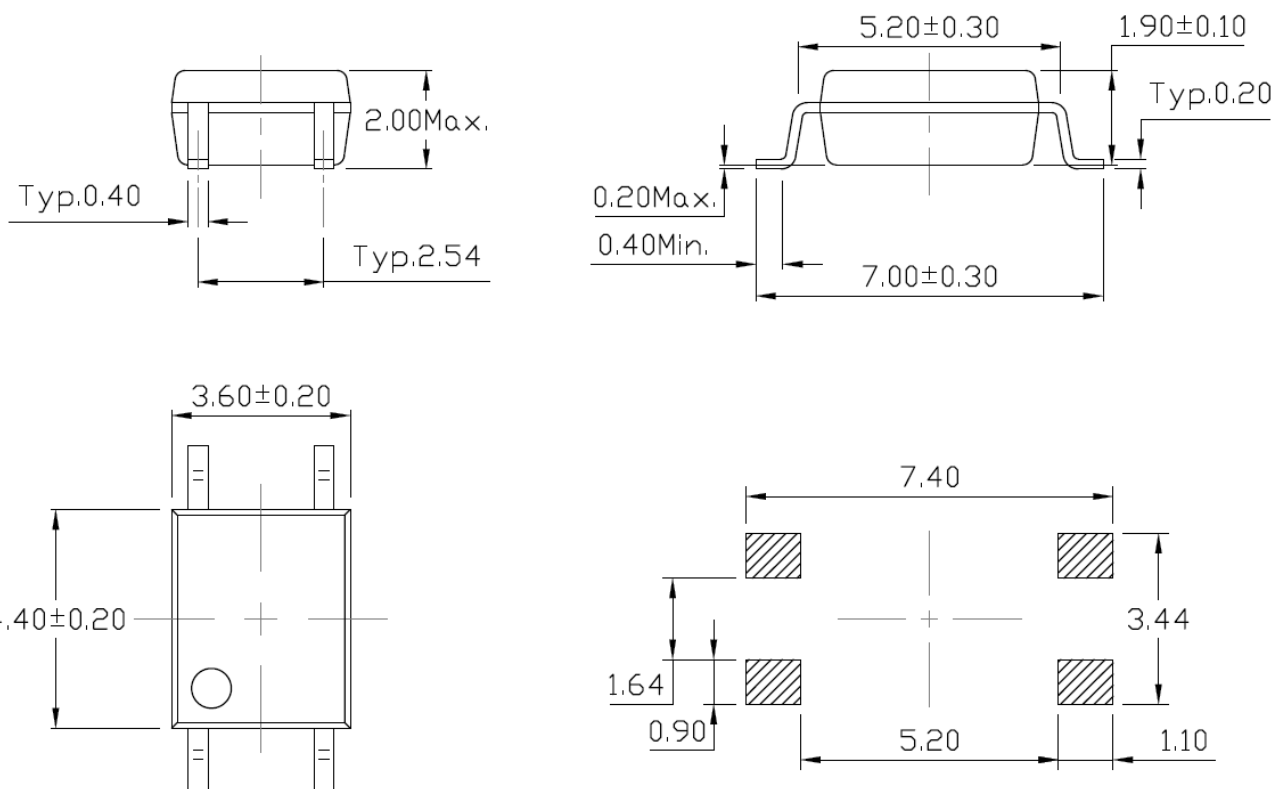
Figure 13: Switching Time Test Circuit



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# CT415 Series DC Input 4-Pin Mini-Flat DMC-Isolator® Photodarlington Optocoupler

## Package Dimension *Dimensions in mm unless otherwise stated*



## Marking Information



### Note:

- CT : Denotes "CT Micro"
- 415 : Part Number
- X : CTR Rank
- V : VDE Safety Mark Option (Blank or V)
- Y : One Digit Year Code
- WW : Two Digit Work Week
- K : Manufacturing Code



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# CT415 Series DC Input 4-Pin Mini-Flat DMC-Isolator® Photodarlington Optocoupler

## Ordering Information

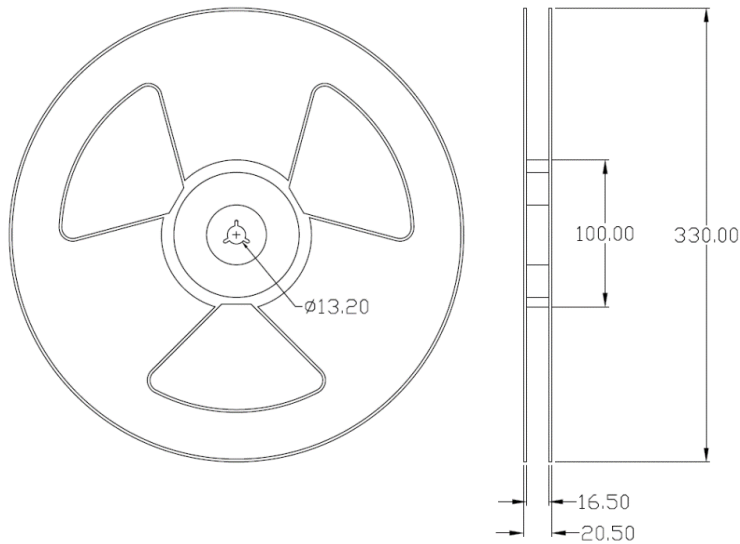
### CT415X (V)(Z)

- CT = Denotes "CT Micro"
- 415 = Part Number
- X = CTR Rank Option (Blank, A or B)
- V = VDE Safety Mark Option (Blank or V)
- Z = Tape and Reel Option (T1 or T2)

Option	Description	Quantity
T1	Surface Mount Lead Forming – With Option 1 Taping	3000 Units/Reel
T2	Surface Mount Lead Forming – With Option 2 Taping	3000 Units/Reel

## Reel Dimension *All dimensions are in mm, unless otherwise stated*

### Option T1/T2



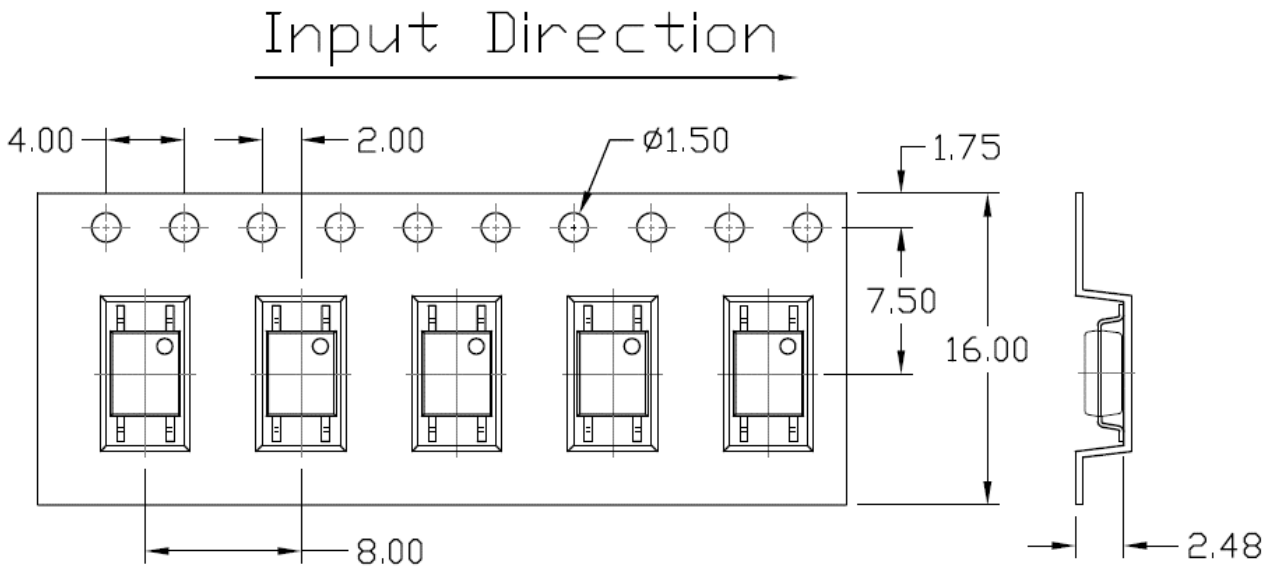




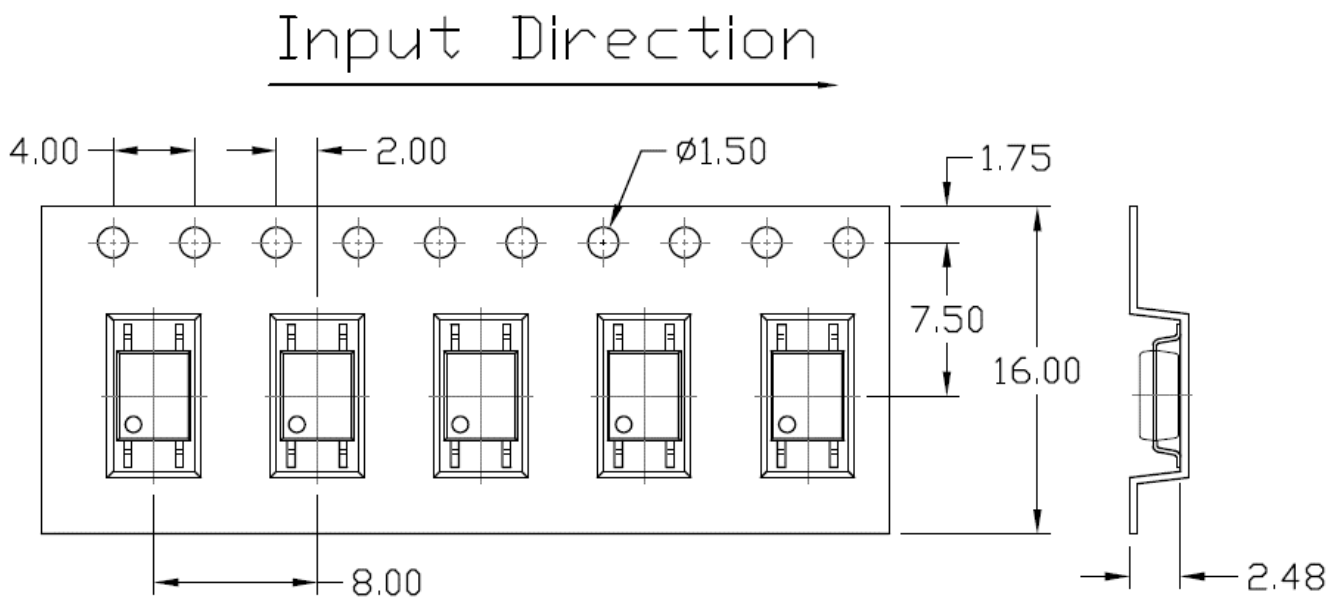
# CT415 Series DC Input 4-Pin Mini-Flat DMC-Isolator® Photodarlington Optocoupler

## Carrier Tape Specifications *Dimensions in mm unless otherwise stated*

### Option (T1)



### Option (T2)





## Solderability spec (Follow the JEDEC standard JESD22-B102)

Reflow Soldering: Immersed surface, other than the end of pin as cut-surface, must be covered by solder.

Solder-Bath: More than 95% of the electrode must be covered with solder.

## Wave soldering (Follow the JEDEC standard JESD22-A111)

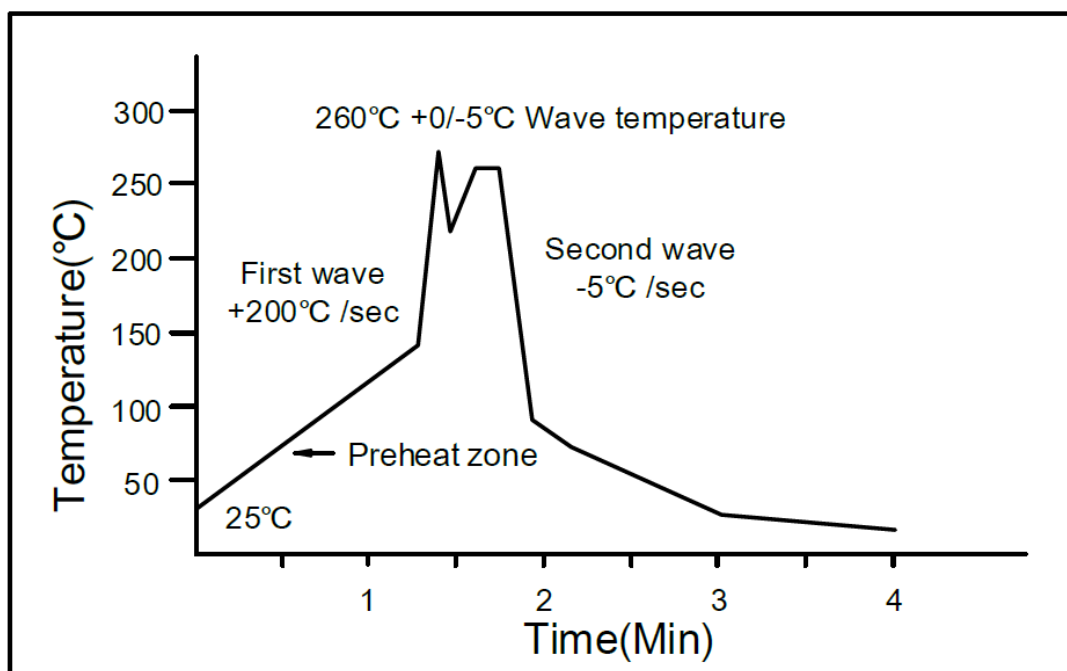
One time soldering is recommended within the condition of temperature.

Temperature:  $260 \pm 0/-5^\circ\text{C}$ .

Time: 10 sec.

Preheat temperature: 25 to  $140^\circ\text{C}$ .

Preheat time: 30 to 80 sec.



## Iron soldering (Follow the standard MIL-STD 202G, Method 210F)

Allow single lead soldering in every single process.

One time soldering is recommended. Temperature:  $350 \pm 10^\circ\text{C}$

Time: 5 sec max.

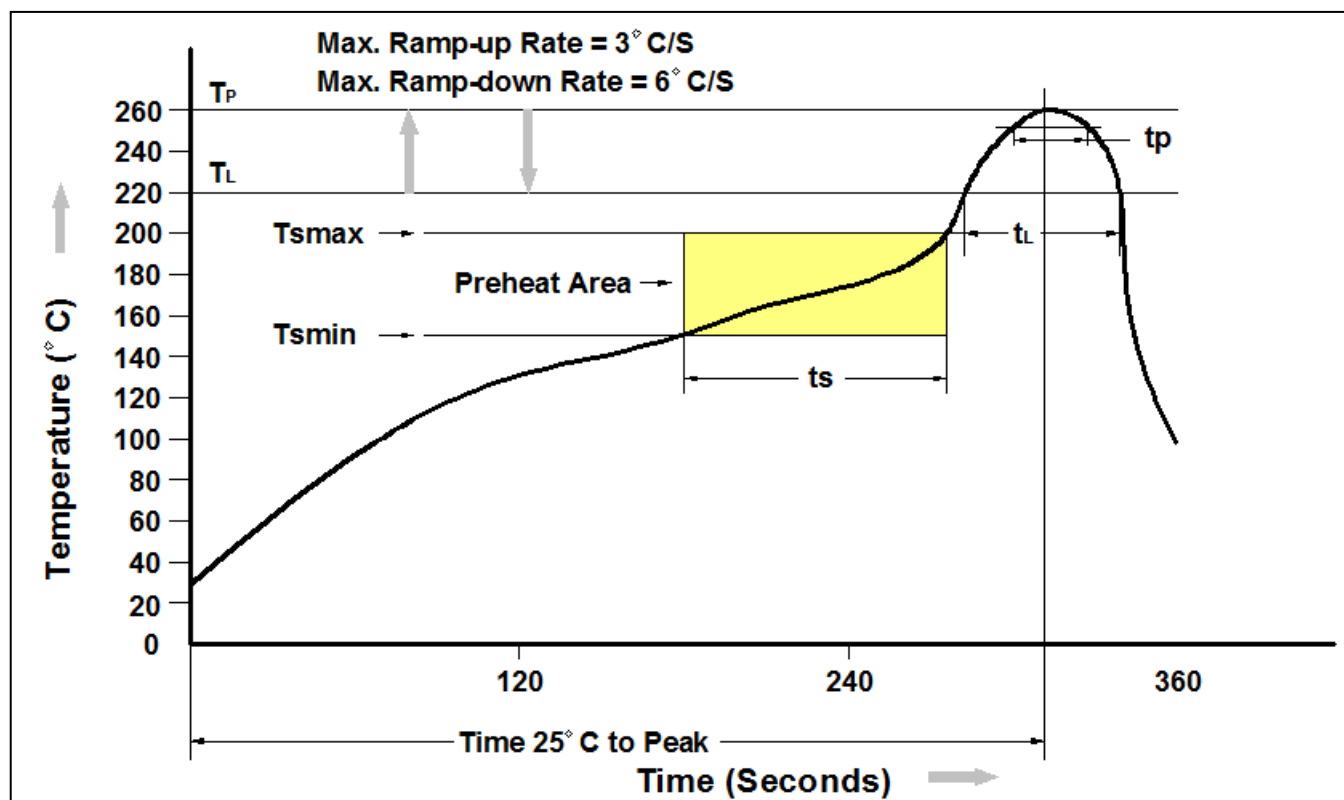


# CT415 Series

## DC Input 4-Pin Mini-Flat DMC-Isolator<sup>®</sup>

### Photodarlington Optocoupler

### Reflow Profile (Follow the JEDEC standard J-STD-020)



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T <sub>smin</sub> )	150°C
Temperature Max. (T <sub>smax</sub> )	200°C
Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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